

DELL Latitude 5450 Intel Core Ultra 5 125U Sülearvuti 35,6 cm (14") Full HD 8 GB DDR5-SDRAM 512 GB SSD Wi-Fi 6E (802.11ax) Windows 11 Pro Hall

Brand : DELL

Product family: Latitude

Product code: N006L545014EMEA VP



Product name : 5450

DELL Latitude 5450. Toote tüüp: Sülearvuti, Toote kuju: Kokkukäiv. Protsessori perekond: Intel Core Ultra 5, Protsessori mudel: 125U. Ekraani diagonaal: 35,6 cm (14"), HD tüüp: Full HD, Ekraani resolutsioon: 1920 x 1080 pikslit. Sisemälu: 8 GB, Sisemälu tüüp: DDR5-SDRAM. Salvestusmaht kokku: 512 GB, Salvestusseade: SSD. Pardagraafika adapteri mudel: Intel Graphics. Installitud operatsioonisüsteem: Windows 11 Pro. Toote värv: Hall. Kaal: 1,4 kg



Design		Network	
-			W/ 5' 65 (000 11.)
Product type *	Laptop	Top Wi-Fi standard *	Wi-Fi 6E (802.11ax)
Product colour *	Grey	Wi-Fi standards	802.11a, Wi-Fi 5 (802.11ac), 802.11b, 802.11g, Wi-Fi 4
Form factor *	Clamshell	Will Standards	(802.11n), Wi-Fi 6E (802.11ax)
Market positioning	Business	Mobile network connection *	×
Display		Wi-Fi data rate (max)	2400 Mbit/s
Display diagonal *	35.6 cm (14")	Antenna type	2x2
Display resolution *	1920 x 1080 pixels	WLAN controller model	Intel Wi-Fi 6E AX211
Touchscreen *	×	WLAN controller manufacturer	Intel
HD type	Full HD	Ethernet LAN	1
Panel type	IPS	Ethernet LAN data rates	10,100,1000 Mbit/s
LED backlight	Image: A start of the start	Bluetooth	 Image: A second s
Native aspect ratio	16:9		
Anti-glare screen	1	Ports & interfaces	
Display brightness	250 cd/m ²	USB 3.2 Gen 1 (3.1 Gen 1) Type-A ports quantity *	2
Pixel density	157 ppi	Ethernet LAN (RJ-45) ports	1
Maximum refresh rate	60 Hz	HDMI ports quantity *	1
Processor		HDMI version	2.1
Processor manufacturer *	Intel	Thunderbolt 4 ports quantity	2
Processor family *	Intel Core Ultra 5	Intel® Thunderbolt 4	1
Processor generation	Intel [®] Core [™] Ultra (Series 1)	Combo headphone/mic port	1
Processor model *	1250	Charging port type	USB Type-C
Processor cores	12	USB Type-C DisplayPort Alternate	✓
Processor threads	14	Mode	•
Processor boost frequency	4.3 GHz	PowerShare	1
Performance cores	2	Number of USB ports with	1
Efficient cores	8	PowerShare support	-
Low Power Efficient-cores	2	Performance	

ProcessorPerformances or bar large frequency4.3 GPa Autorbord dipset instance Autorbord dipset instance Autorbord dipset instance Autorbord dipset instance Performances or base frequency Performances or base frequencyPerformances or base frequency Performances or base frequency Performances or base frequency Performances or base frequencyPerformances or base frequency Performances or base frequency Per				
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Inversion FrequencyNo MHzAvecade noncinePrecision PrecisionNon-MHZPrecision PrecisionNon-MHZPrecision 	Performance-core base frequency	1.3 GHz	Numeric keypad *	×
FrequencyNumberOtherOperating system architecture6 4bitProcessor cache byseSmart CacheThal softwareMicrosof Diric Friel McAfee Business Protection 1-yearMaximum turbo power5 WOperating system instaled.**Windows 11 ProNeural processor unit (NPU)I feld A BoostNumber of battery cells3Maximum frequency NPU14 GH2Battery capacity capacity34 Windows 11 ProSparsity support14 GH2Battery capacity capacity34 Windows 11 ProMaximum frequency NPU14 GH2Battery capacity capacity20 9Al databare frequencyProtectureBattery verbarge time31 AAl databare frequencyDirectul, CaynotyBattery verbarge time30 NoAl databare frequencyDirectul, CaynotyBattery verbarge time30 NoAl databare frequencySinge ChannelCadapter frequency300 NoNormory Singe ChannelDirectul, CaynotyAC adapter frequency300 NoNormory Singe ChannelSinge ChannelCable Ick skillWedgeMemory Josoft (Sift Sxi Szi2, So-DMMCable Ick skillWedgeMemory Singe ChannelSinge ChannelCable Ick skillWedgeSinge ChannelSinge ChannelCable Ick skillWedgeSinge ChannelSinge ChannelCable Ick skillWedgeMemory Singe ChannelSinge ChannelCable Ick skillWedgeSinge ChannelSinge ChannelSinge ChannelSinge ChannelSinge ChannelSi		0.8 GHz	Keyboard backlit	1
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Instant of partners Segment of partners Fingerprint reader ✓ Storage Trusted Platform Module (TPM) ✓ Total storage capacity * \$12 GB Trusted Platform Module (TPM) ✓ Storage media * SSD Operating temperature (TPT) 0 - 35 °C Total SSDs capacity \$12 GB Operating temperature (T-T) 40 - 65 °C SSD capacity \$12 GB Storage temperature (T-T) 40 - 65 °C SSD capacity \$12 GB Storage temperature (T-T) 40 - 65 °C SSD interface PCI Express 4.0 Operating relative humidity (H-H) 0 - 90% VVMe ✓ Storage relative humidity (H-H) 0 - 90% SSD form factor M.2 Operating altitude 15.2 - 3048 m Optical drive type * × Non-operating altitude 15.2 - 10668 m SSD form factor M.2 Operating shock 100 G Card reader integrated × Statinability operating shock 100 G Sprete graphics card model * Not available Non-operating shock 100 G On-board graph	•	64 GB	Cable lock slot	1
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Joint of the series o	Memory data transfer rate	5600 MT/s	Fingerprint reader	1
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Camera		Carbon footprint	
Front camera resolution Front camera HD type	1920 x 1080 pixels Full HD	Carbon emissions, energy usage (kg of CO2e)	24
Infrared (IR) camera	1	Carbon emissions, end-of-life (kg of CO2e)	2
Privacy camera Privacy type	 Privacy shutter 	Total carbon emissions, w/o use phase (kg of CO2e)	87
		PAIA version	GaBi version 1, 2024
		Packaging content	

Cables included

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